

客户图

NOTES:

1. FINISH:

- 1.1 HOUSING:WHITE,UL94V-0.
- 1.2 CONTACT: PHOSPHOR BRONZE ,GOLD (SEE P/N) PLATED IN CONTACT AREA, 80u" MIN MATTE TIN PLATED IN SOLDER AREA,50u" MIN. NICKEL UNDERPLATED OVERALL.

2. ELECTRICAL:

- 2.1 CURRENT RATING:3A;
- 2.2 DIELECTRIC WITHSTANDING VOLTAGE: 500V AC/MINUTE.
- 2.3 CONTACT RESISTANCE: 30mΩ MAX.
- 2.4 INSULATION RESISTANCE: 1000MΩ MIN.
- 2.5 OPERATION TEMPERATURE:-40°C TO +125°C.

3.ORDER INFORMATION:

63D3-F XXX XX 075 C 01

Pin数码

020=2x10PIN
030=2x15PIN
040=2x20PIN

端子电镀:

S1=1u" Gold/Tin
S2=3u" Gold/Tin
S3=5u" Gold/Tin
S4=10u" Gold/Tin
S5=15u" Gold/Tin
S6=30u" Gold/Tin

塑胶高度:

075=7.50mm

包装方式:

C=TRAY

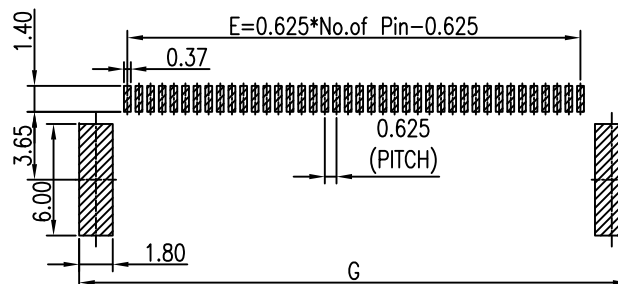
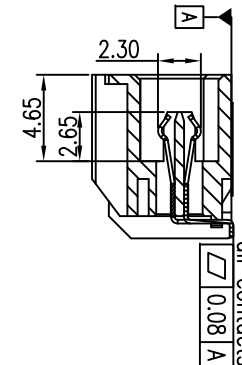
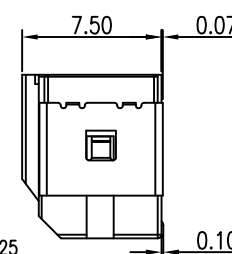
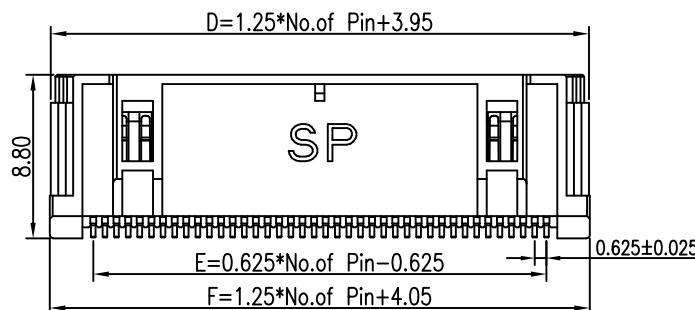
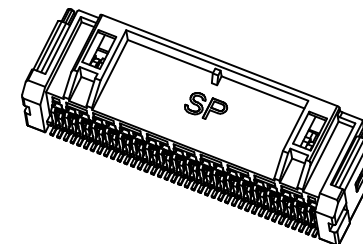
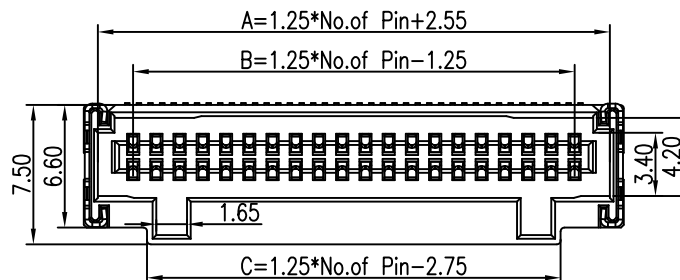


TABLE1:

No. OF PIN	A	B	C	D	E	F	G
020:2x10PIN	15.05	11.25	9.75	16.45	11.875	16.55	17.00
030:2x15PIN	21.30	17.50	16.00	22.70	18.125	22.80	23.25
040:2x20PIN	27.55	23.75	22.25	28.95	24.375	29.05	29.50

RECOMMENDED PCB LAYOUT(TOP SIDE)
PCB BOARD TOLFRANCF±0.05

						OPERATION	DRAW	MR.Zeng	2023.11.21	SOLEPIN 东莞市硕品电子有限公司 Professional connector manufacturer DONGGUAN SOLEPIN ELECTRONICS CO., LTD.			
						X.X ±0.40	DESIGN	Jensen	2023.11.21				
						X.XX ±0.25	CHECK	Jack	2023.11.21				
						X.XXX ±0.15	APPROVE	Andy	2023.11.21				
AO						Angle ±3°				SHEET	1/1	TITLE:	1.25 W/B CONN. DUAL R/A REC.ASS'Y
REV	DATE					DIM. TOL	UNIT	mm	SCALE	1:1	PROJ.	DRAW NO.	SP-835